

SSCU11N20GN2

SSCU11N20GN2

N-Channel Enhancement Mode MOSFET

Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	ID
20V	±12V	11mΩ@10V	
		13mΩ@4V5	12A
		16mΩ@2V5	

Description

This device is produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package.

- > Applications
- Load Switch
- Portable Devices
- DCDC Conversion
- Charging

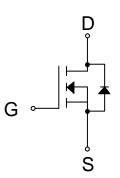
> Ordering Information

Device	Package	Shipping		
SSCU11N20GN2	DFN2020-6L	3000/Reel		

> Pin Configuration



DFN2020-6L (Bottom View)



Pin Configuration





> Absolute Maximum Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit		
Drain-to-Source Voltage		V _{DS}	20	V	
Gate-to-Source Voltage	V _{GS}	±12	V		
Continuous Drain Current ^d	Tc=25℃	1-	12	A	
Continuous Drain Current [®]	Tc=100℃	- ID	7		
Pulsed Drain Current ^b	Ідм	40	А		
	Tc =25 ℃		3.1	w	
Power Dissipation ^c	Tc=100℃	P _D	1.25		
Operation junction temperature		TJ	-55~150	°C	
Storage temperature range		Tstg	-55~150	°C	

> Thermal Resistance Ratings (T_A=25[°]C unless otherwise noted)

Parameter	Symbol Maximum		Unit	
Junction-to-Ambient Thermal Resistance ^a	R _{θJA}	40	°C/W	

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

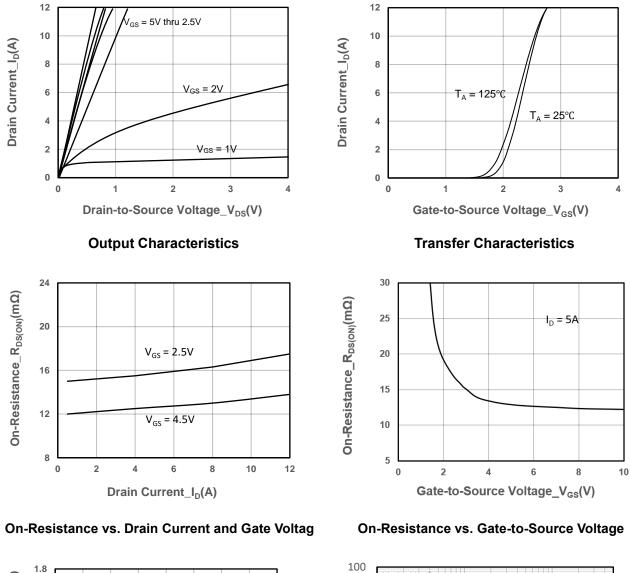


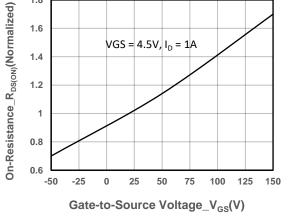
> Electrical Characteristics (T_A=25 $^\circ\!\!\!\!{}^\circ\!\!\!{}^\circ$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250uA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 uA$	0.5	0.7	1.2	V
		V _{GS} = 10V, I _D = 4.5A		11	14	mΩ
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 3.5A		13	17	
		V _{GS} = 2.5V, I _D = 2.5A		16	21	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 16V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	I _{GSS}	$V_{GS} = \pm 12V$, $V_{DS} = 0V$			±100	nA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 0.5A		0.8	1.3	V
Input Capacitance	Ciss	$\lambda = 40 \lambda \lambda = 0 \lambda$		600		pF
Output Capacitance	Coss	$V_{DS} = 10V, V_{GS} = 0V,$		330		
Reverse Transfer Capacitance	C _{RSS}	f = 1MHz		140		
Total Gate Charge	Q _G			8.5		nC
Gate to Source Charge	Q _{GS}	$V_{GS} = 4.5V, V_{DS} = 10V,$		1.8		
Gate to Drain Charge	Q_{GD}	$I_D = 4A$		2.2		
Turn-on Delay Time	T _{D(ON)}			7		ns
Rise Time	Tr	$V_{GS} = 4.5V, V_{DS} = 10V,$		13		
Turn-off Delay Time	T _{D(OFF)}	$R_{\rm L} = 10\Omega, R_{\rm G} = 6\Omega,$		48		
Fall Time	T _f	- I _D = 1A		22		

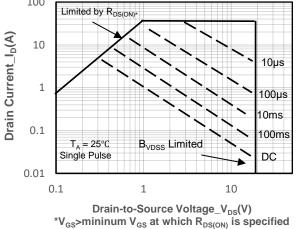


Typical Performance Characteristics (T_A=25℃ unless otherwise noted) \triangleright









Safe Operating Area vs. Junction-to-Ambient

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SSCU11N20GN2

0.55

0.02

0.30

2.00

2 00

0.90

0.30

0.90

0.56

0.25

0.20

0.25

0.60

0.05

0.35

2.05

2 05

1.00

0.35

1.00

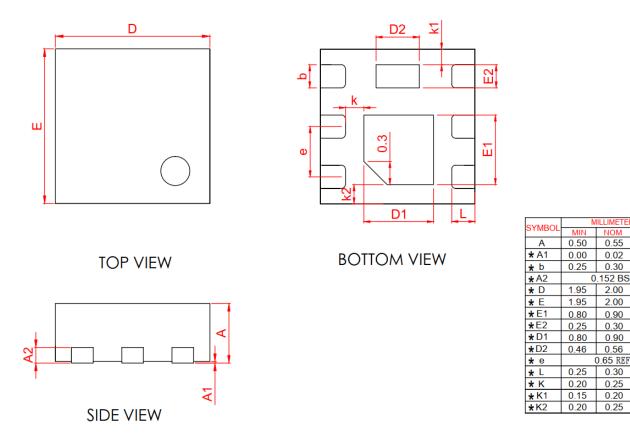
0.66

0.35 0.30

0 25

0.30

Package Information



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